

PUMA68F4006X - 70/90/12

Issue 5.0 December 1999

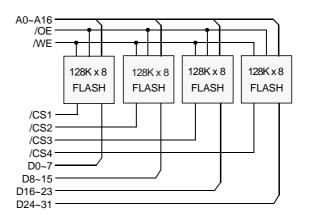
Description

The PUMA68 range of devices provide a high density surface mount industry standard memory solution which may accommodate various memory technologies including SRAM, EEPROM and Flash. The devices are designed to offer a defined upgrade path and may be user configured as 8, 16 or 32 bits wide.

The PUMA68F4006X is a 128Kx32 FLASH module housed in a 68 Jleaded package which complies with the JEDEC 68 PLCC standard. Access times of 70, 90 or 120ns are available. The 5V device is available to commercial and industrial temperature grade.

 $512K \times 32$, $1M \times 32$ and 2Mx32 FLASH PUMA68 devices are available in the same footprint to offer a defined upgrade path.

Block Diagram



Features

- Access times of 70, 90 and 120ns.
- •5V ± 10%.
- Commercial and Industrial temperature grades
- JEDEC Standard 68 PLCC footprint.
- Industry standard pinout.
- User configurable as 8 / 16 / 32 bits wide.
- 10 Year Data Retention
- Write Erase Cycle Endurance 100,000 (min)
- Automatic Write/Erase by Embedded Algorithm
- Uniform Sector Device.

Pin Definition See page 2.

Pin Functions

Description	Signal	
Address Input	A0~A16	
Data Input/Output	D0~D31	
Chip Select	/CS1~4	
Write Enable	/WE	
Output Enable	/OE	
No Connect	NC	
Power	V_{CC}	
Ground	V _{SS}	

Package Details

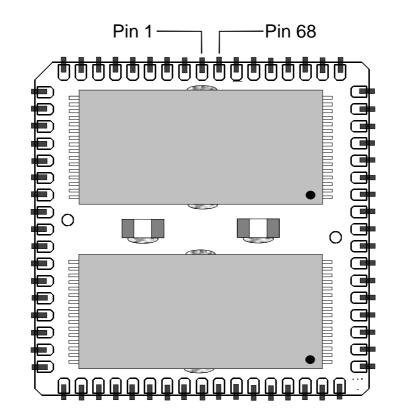
Plastic 'J' Leaded JEDEC PLCC Max. Dimensions (mm) - 25.27 x 25.27 x 5.08

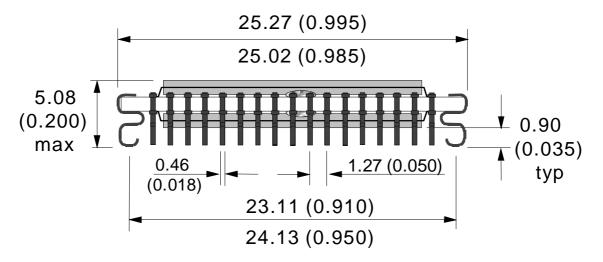
Pin Definition - PUMA68F4006X

Pin	Signal	Pin	Signal
1	V_{CC}	35	V_{CC}
2	NC	36	A13
3	/CS1	37	A12
4	/CS2	38	A11
5	/CS3	39	A10
6	/CS4	40	A9
7	NC	41	A8
8	NC	42	A7
9	D16	43	D0
10	D17	44	D1
11	D18	45	D2
12	D19	46	D3
13	V_{SS}	47	V_{SS}
14	D20	48	D4
15	D21	49	D5
16	D22	50	D6
17	D23	51	D7
18	V_{cc}	52	V_{CC}
19	D24	53	D8
20	D25	54	D9
21	D26	55	D10
22	D27	56	D11
23	V_{SS}	57	V_{SS}
24	D28	58	D12
25	D29	59	D13
26	D30	60	D14
27	D31	61	D15
28	A6	62	A14
29	A5	63	A15
30	A4	64	A16
31	А3	65	/WE
32	A2	66	/OE
33	A1	67	NC
34	A0	68	NC

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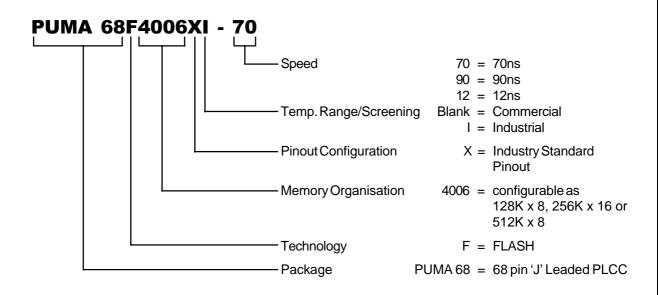
PUMA 68 pin JEDEC Surface Mounted PLCC





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Ordering Information



Note:

Although this data is believed to be accurate the information contained herein is not intended to and does not create any warranty of merchantibility or fitness for a particular purpose.

Our products are subject to a constant process of development. Data may be changed without notice.

Products are not authorised for use as critical components in life support devices without the express written approval of a company director.

Co Planarity

Specified as +/- 2 thou max.

Visual Inspection Standard

All devices inspected to ANSI/J-STD-001B Class 2 standard

Moisture Sensitivity

Devices are moisture sensitive.

Shelf Life in Sealed Bag 12 months at <40°C and <90% relative humidity (RH).

After this bag has been opened, devices that will be subjected to infrared reflow, vapour phase reflow, or equivalent processing (peak package body temp 220°C) **must be** :

A: Mounted within 72 Hours at factory conditions of <30°C/60% RH

OR

B: Stored at <20% RH

If these conditions are not met or indicator card is >20% when read at 23°C +/-5% devices **require baking** as specified below.

If baking is required, devices may be baked for :-

A: 24 hours at 125°C +/-5% for high temperature device containers

OR

B: 192 hours at 40°C +5°C/-0°C and <5% RH for low temperature device containers.

Packaging Standard

Devices packaged in dry nitrogen, JED-STD-020.

Packaged in trays as standard.

Tape and reel available for shipment quantities exceeding 200pcs upon request.

Soldering Recomendations

IR/Convection - Ramp Rate 6°C/sec max.

Temp. exceeding 183°C 150 secs. max.

Peak Temperature 225°C

Time within 5°C of peak 20 secs max. Ramp down 6°C/sec max.

Vapour Phase - Ramp up rate 6°C/sec max.

Peak Temperature 215 - 219°C Time within 5°C of peak 60 secs max. Ramp down 6°C/sec max.

The above conditions must not be exceeded.

Note: The above recommendations are based on standard industry practice. Failure to comply with the above recommendations invalidates product warranty.

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